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RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

SAW Components

SAW RF filter

Series/type: B3522 Ordering code: B39162B3522U410

Date:January 25, 2013Version:2.5

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SAW Components

SAW RF filter GPS

Series/type: Ordering code:

Date:

B3522 B39162B3522U410 January 25, 2013 2.5

Version:

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Application

■ Low-loss RF filter for GPS application

No matching network required for operation at 50 Ω



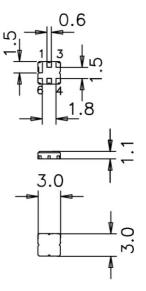
Features

SAW Components

SAW RF filter

SMD

- Package size 3.0 x 3.0 x 1.1 mm³
- Package code DCC6C
- RoHS compatible
- Approximate weight 0.037 g
- Package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Lead free soldering compatible with J STD20C
- AEC-Q200 qualified component family
- Electrostatic Sensitive Device (ESD)



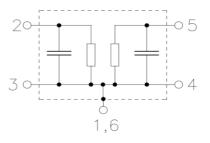
微TDK

1575.42 MHz

B3522

Pin configuration

■ 2	Input
■ 5	Output
∎ 1,3,4,6	Ground



Characteristics

Temperature range for	$T = -40 \degree C \text{ to } +85$
specification:	°C
Terminating source	$Z_s = 50\Omega$
impedance:	
Terminating load impedance:	Z _L = 50 Ω

	min.	typ. @ 25 °C	max.	
Center frequency f _C	_	1575.42	_	MHz
Maximum insertion attenuation				
α _{max} 1574.397 1576.443MHz	_	1.6	2.0	dB
Amplitude ripple (p-p) Δα 1574.397 1576.443MHz	_	0.2	0.8	dB
Input VSWR				
1574.397 1576.443MHz	_	1.4	1.8	
Please read cautions and warnings an	d			

Please read cautions and warnings and

January 25, 2013 important notes at the end of this document.

Data sheet

SAW Components

SAW RF filter

Output VSWR				
1574.397				
1576.443MHz	_	1.3	1.8	
Attenuation α				
10.00 1450.00 MHz	40	43		dB
1450.00 1500.00 MHz	35	45		dB
1625.00 1640.00 MHz	35	50		dB
1640.00 1800.00 MHz	44	47		dB
1800.00 2000.00 MHz	42	44		dB
2000.00	30	35		dB
3000.00 MHz	00	00		UD
Characteristics Temperature range for T =	40 °C	c to+105		
Temperature range for T = specification:	= —40 C °C	, 10+105		
•	= 50Ω			
impedance:	- 3012			
Terminating load impedance: $Z_{L} =$	= 50 Ω			
	min.	typ.	max.	
		@ 25 °C	maxi	
Center frequency f _c		1575.42		MHz
		-		MHz
Center frequencyfcMaximum insertion attenuation		-		MHz
Maximum insertion attenuation α_{max}		-		MHz
Maximum insertion attenuation α_{max} 1574.397		1575.42	_	
Maximum insertion attenuation α _{max} 1574.397 1576.443MHz	_	-	2.2	MHz dB
Maximum insertion attenuation α _{max} 1574.397 1576.443MHz Amplitude ripple (p-p) Δα	_	1575.42	2.2	
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1574.397	_	1575.42		dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz	_	1575.42	 2.2 1.0	
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Isoro 1576.443MHz	_	1575.42		dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Ispression 1574.397 1576.443MHz	_	1575.42 1.6 0.2	1.0	dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Ispace 1574.397 1576.443MHz	_	1575.42		dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Input VSWR 1574.397 1576.443MHz	_	1575.42 1.6 0.2	1.0	dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Input VSWR 1576.443MHz Ispression 1576.443MHz Ispression 1576.443MHz Ispression 1576.443MHz	_	1575.42 1.6 0.2 1.4	1.0 1.9	dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Input VSWR 1574.397 1576.443MHz	_	1575.42 1.6 0.2	1.0	dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Input VSWR 1576.443MHz Ispression 1576.443MHz Ispression 1576.443MHz Ispression 1576.443MHz	_	1575.42 1.6 0.2 1.4	1.0 1.9	dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Output VSWR 1574.397 1576.443MHz Λα 1576.443MHz Λα 1576.443MHz Δα 1576.443MHz Λα 1574.397 1576.443MHz Λα Δα Δα Λα Λα	 	1575.42 1.6 0.2 1.4 1.3	1.0 1.9	dB dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Input VSWR 1574.397 1576.443MHz Output VSWR 1574.397 1576.443MHz Attenuation α 10.00 1450.00 MHz	 40	1575.42 1.6 0.2 1.4 1.3 43	1.0 1.9	dB dB
Maximum insertion attenuation αmax 1574.397 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Amplitude ripple (p-p) Δα 1576.443MHz Input VSWR 1574.397 1576.443MHz Output VSWR 1574.397 1576.443MHz Λα 1576.443MHz Λα 1576.443MHz Δα 1576.443MHz Λα 1574.397 1576.443MHz Λα Δα Δα Λα Λα	 40 33 35	1575.42 1.6 0.2 1.4 1.3	1.0 1.9	dB dB

SMD

Please read cautions and warnings and

1640.00 ... 1800.00 MHz

1800.00 ... 2000.00 MHz

January 25, 2013 important notes at the end of this document.

44

42

3

47

44

dB

dB



B3522

1575.42 MHz

Data sheet

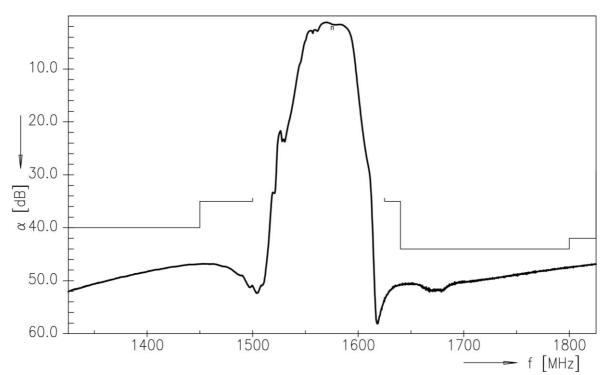
SAW Components

SAW RF filter 1575.42 MHz =MD 2000.00 ... 30 35 dB 3000.00 MHz **Maximum ratings** Operable temperature range Т -45/+125 °C Storage temperature range -45/+125 °C Tstg ٧ DC voltage VDC 6 P_{S} Source power 10 dBm source impedance 50 Ω 20 dBm 824 MHz to 915 MHz, 1710 MHz to 1785 MHz, 1850 MHz to 1910 MHz

公TDK

B3522

Transfer function



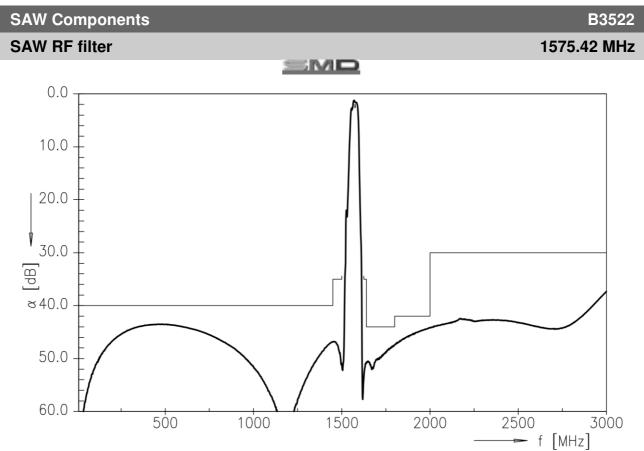
Transfer function (wideband)

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4

Data sheet



ESD protection of SAW filters

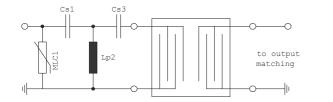
SAW filters are Electro Static Discharge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

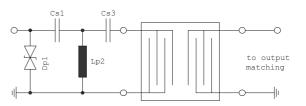
In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wideband filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.





ГОК

Fig. 1 MLC varistor plus ESD matching

Fig. 2 Suppressor diode plus ESD matching

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

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B3522

ГОК

1575.42 MHz

SAW RF filter

SAW Components

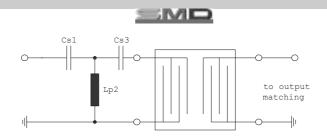


Fig. 3 3rd order high-pass structure for basic ESD protection

In all three figures the shunt inductor Lp2 could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available pcb space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements

For further information, please refer to EPCOS Application report:

"ESD protection for SAW filters".

This report can be found under <u>www.epcos.com/rke</u>.Click on "Applications Notes".

References

Туре	B3522
Ordering code	B39162B3522U410
Marking and package	C61157-A7-A67
Packaging	F61074-V8168-Z000
Date codes	L_1126
S-parameters	B3522_NB.s2p, B3522_WB.s2p See file header for port/pin assignment table.
Soldering profile	S_6001
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

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SAW Components

SAW RF filter

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Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>

=MD

For further information please contact your local EPCOS sales office or visit our webpage at <u>www.epcos.com</u>.

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B3522

1575.42 MHz



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